

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Yoshihito Ishibashi	03/15/2011
Shigeru Tajima	03/15/2011
Daisuke Yamazaki	04/11/2011
Masahiro Suzuki	04/11/2011
RECEIVING PARTY DATA	
Name:	Sony Corporation
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13087917
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	3712174-02619
NAME OF SUBMITTER:	Thomas C. Basso
Total Attachments: 4 source=Executedpapers#page1.tif source=Executedpapers#page2.tif source=Executedpapers#page3.tif source=Executedpapers#page4.tif	

CH \$40.00 13087917

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in BATTERY CONTROLLER, BATTERY CONTROL METHOD AND PROGRAM

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries:

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto:

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense:

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto:

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 13/087,917 Filing Date: April 15, 2011

This assignment executed on the dates indicated below.

YOSHIHITO ISHIBASHI

Name of first or sole inventor
TOKYO JAPAN

Residence of first or sole inventor
Yoshihito Ishibashi
Signature of first or sole inventor

Execution date of U.S. Patent Application

March 15, 2011
Date of this assignment

SHIGERU TAJIMA

Name of second inventor
KANAGAWA JAPAN

Residence of second inventor
Shigeru Tajima
Signature of second inventor

Execution date of U.S. Patent Application

March 15, 2011
Date of this assignment

DAISUKE YAMAZAKI

Name of third inventor
KANAGAWA JAPAN

Residence of third inventor

Signature of third inventor

Execution date of U.S. Patent Application

Date of this assignment

ADDITIONAL INVENTOR(S)

MASAHIRO SUZUKI Name of fourth inventor KANAGAWA JAPAN Residence of fourth inventor	Execution date of U.S. Patent Application
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment
Name of sixth inventor	Execution date of U.S. Patent Application
Residence of sixth inventor	
Signature of sixth inventor	Date of this assignment
Name of seventh inventor	Execution date of U.S. Patent Application
Residence of seventh inventor	
Signature of seventh inventor	Date of this assignment
Name of eighth inventor	Execution date of U.S. Patent Application
Residence of eighth inventor	
Signature of eighth inventor	Date of this assignment
Name of ninth inventor	Execution date of U.S. Patent Application
Residence of ninth inventor	
Signature of ninth inventor	Date of this assignment

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NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

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TOKYO JAPAN

Residence of First or sole inventor

Signature of first or sole inventor

Execution date of U.S. Patent Application

Date of this assignment

SHIGERU TAJIMA

Name of second inventor

KANAGAWA JAPAN

Residence of second inventor

Signature of second inventor

Execution date of U.S. Patent Application

Date of this assignment

DAISUKE YAMAZAKI

Name of third inventor

KANAGAWA JAPAN

Residence of third inventor

Daisuke Yamazaki
Signature of third inventor

Execution date of U.S. Patent Application

11. April, 2011
Date of this assignment

ADDITIONAL INVENTOR(S)

MASAHIRO SUZUKI

Name of fourth inventor
KANAGAWA JAPAN

Residence of fourth inventor

Masahiro Suzuki
Signature of fourth inventor

Execution date of U.S. Patent Application

11. April. 2011
Date of this assignment

Name of fifth inventor

Residence of fifth inventor

Signature of fifth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of sixth inventor

Residence of sixth inventor

Signature of sixth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of seventh inventor

Residence of seventh inventor

Signature of seventh inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of eighth inventor

Residence of eighth inventor

Signature of eighth inventor

Execution date of U.S. Patent Application

Date of this assignment

Name of ninth inventor

Residence of ninth inventor

Signature of ninth inventor

Execution date of U.S. Patent Application

Date of this assignment